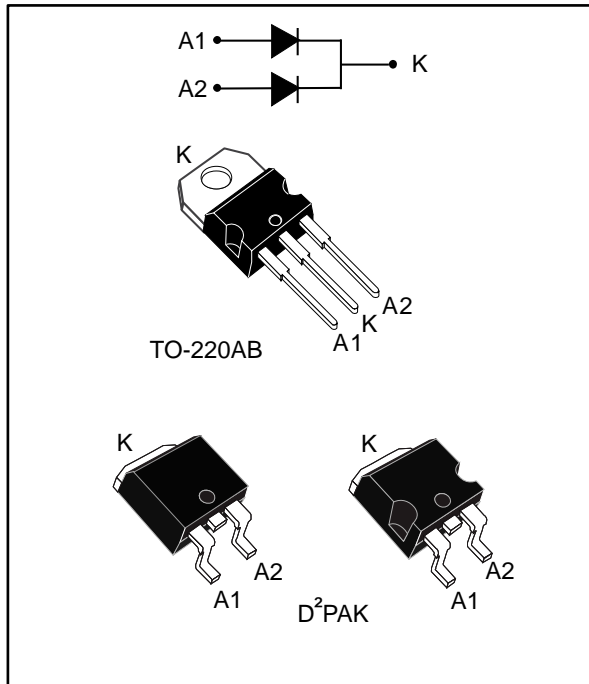


Ultrafast recovery diode

Datasheet - production data



Description

This series uses ST's new 400 V planar Pt doping technology. This device is specially suited for switching mode base drive and transistor circuits.

Packaged in through-the-hole and surface mount packages, this device is intended for use in low voltage, high frequency inverters, freewheeling and polarity protection.

Table 1: Device summary

| Symbol | Value |
|----------------|---------|
| $I_{F(AV)}$ | 2 x 8 A |
| V_{RRM} | 400 V |
| T_j (max) | 175 °C |
| V_F (typ) | 0.9 V |
| t_{rr} (typ) | 25 ns |

Features

- Very low switching losses
- High frequency and/or high pulsed current operation
- High junction temperature
- ECOPACK®2 compliant component for D²PAK on demand

1 Characteristics

Table 2: Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

| Symbol | Parameter | | | Value | Unit |
|---------------------|---|-----------------------------------|------------|-------------|------|
| V _{RRM} | Repetitive peak reverse voltage | | | 400 | V |
| I _{F(RMS)} | Forward rms current | | | 30 | A |
| I _{F(AV)} | Average forward current δ = 0.5, square wave | T _C = 150 °C | Per diode | 8 | A |
| | | T _C = 145 °C | Per device | 16 | |
| I _{FSM} | Surge non repetitive forward current | t _p = 10 ms sinusoidal | | 120 | A |
| T _{stg} | Storage temperature range | | | -65 to +175 | °C |
| T _j | Maximum operating junction temperature range | | | -40 to +175 | °C |

Table 3: Thermal parameter

| Symbol | Parameter | | Max. value | Unit |
|----------------------|------------------|------------|------------|------|
| R _{th(j-c)} | Junction to case | Per diode | 2 | °C/W |
| | | Per device | 1.15 | |
| R _{th(c)} | Coupling | | 0.3 | °C/W |

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_{j(\text{diode}1)} = P_{(\text{diode}1)} \times R_{th(j-c)} \text{ (per diode)} + P_{(\text{diode}2)} \times R_{th(c)}$$

Table 4: Static electrical characteristics (per diode)

| Symbol | Parameter | Test conditions | | Min. | Typ. | Max. | Unit |
|-------------------------------|-------------------------|-------------------------|-----------------------------------|------|------|------|------|
| I _R ⁽¹⁾ | Reverse leakage current | T _j = 25 °C | V _R = V _{RRM} | - | | 10 | μA |
| | | T _j = 125 °C | | - | 10 | 100 | |
| V _F ⁽²⁾ | Forward voltage drop | T _j = 25 °C | I _F = 8 A | - | | 1.5 | V |
| | | T _j = 100 °C | | - | 1.05 | 1.3 | |
| | | T _j = 150 °C | | - | 0.9 | 1.1 | |
| | | T _j = 25 °C | I _F = 16 A | - | | 1.75 | |
| | | T _j = 100 °C | | - | 1.25 | 1.55 | |
| | | T _j = 150 °C | | - | 1.12 | 1.37 | |

Notes:

⁽¹⁾Pulse test: t_p = 5 ms, δ < 2%

⁽²⁾Pulse test: t_p = 380 μs, δ < 2%

To evaluate the conduction losses, use the following equation:

$$P = 0.83 \times I_{F(AV)} + 0.034 \times I_{F(RMS)}^2$$

Table 5: Dynamic electrical characteristics (per diode)

| Symbol | Parameter | Test conditions | | Min. | Typ. | Max. | Unit |
|---------------------|--------------------------|-------------------------|---|--|------|------|------|
| t _{rr} | Reverse recovery time | T _j = 25 °C | I _F = 1 A V _R = 30 V di _F /dt = -50 A/μs | - | 35 | 50 | ns |
| | | | I _F = 1 A V _R = 30 V di _F /dt = -100 A/μs | - | 25 | 35 | |
| I _{RM} | Reverse recovery current | T _j = 125 °C | I _F = 8 A V _R = 320 V di _F /dt = -200 A/μs | - | 5.5 | 8 | A |
| S _{factor} | Softness factor | | | - | 0.4 | - | - |
| t _{fr} | Forward recovery time | T _j = 25 °C | I _F = 8 A V _{FR} = 1.1 x V _{F(max)} di _F /dt = 100 A/μs | - | | 150 | ns |
| V _{FP} | Forward recovery voltage | | | I _F = 8 A di _F /dt = 100 A/μs | - | 2.9 | |

1.1 Characteristics (curves)

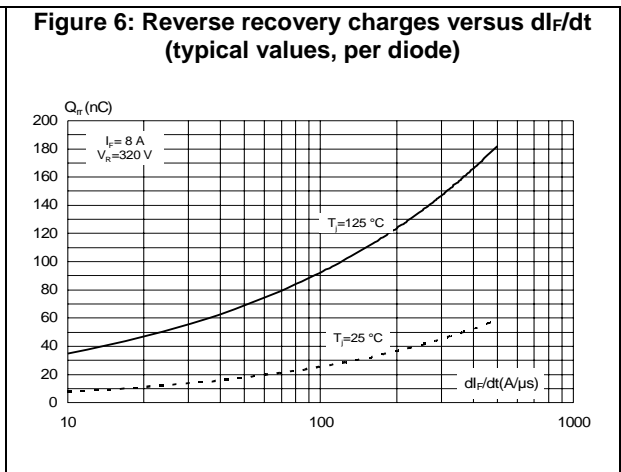
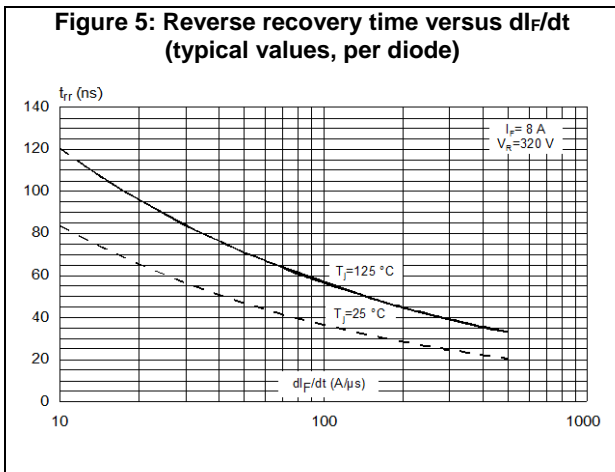
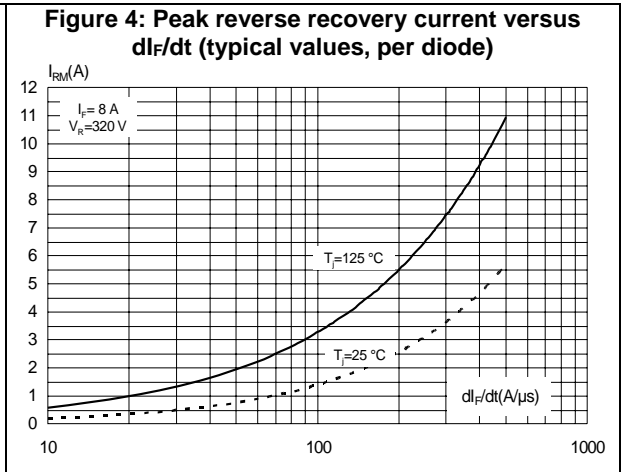
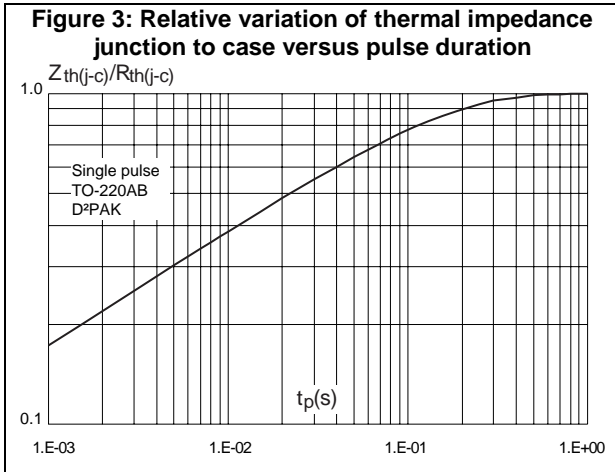
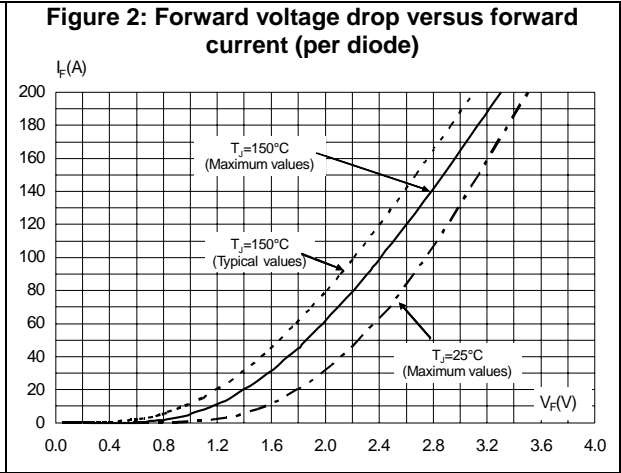
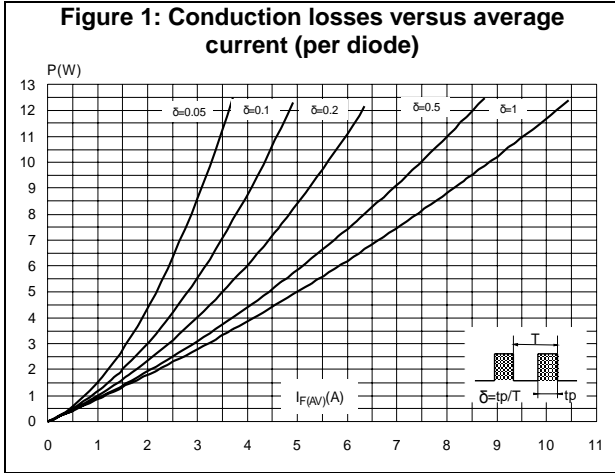


Figure 7: Relative variations of dynamic parameters versus junction temperature (reference: $T_j = 125^\circ\text{C}$)

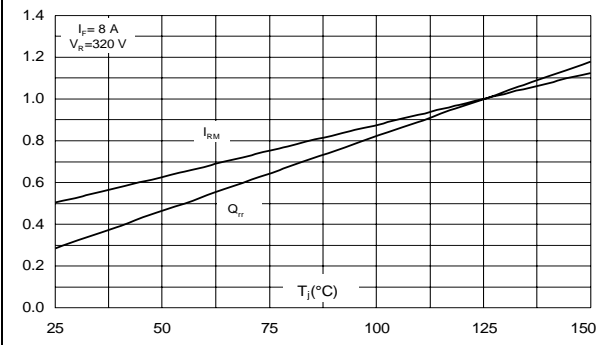


Figure 8: Transient peak forward voltage versus di_F/dt (typical values, per diode)

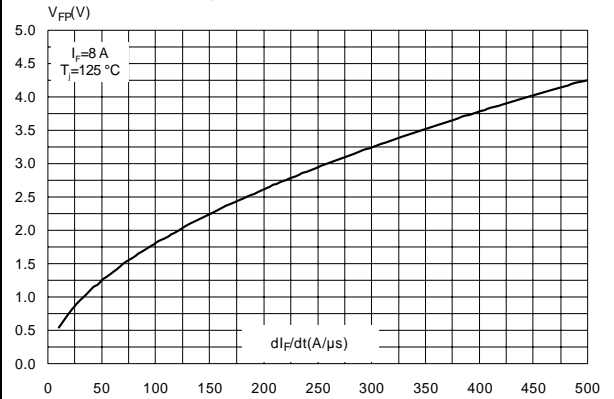


Figure 9: Forward recovery time versus di_F/dt (typical values, per diode)

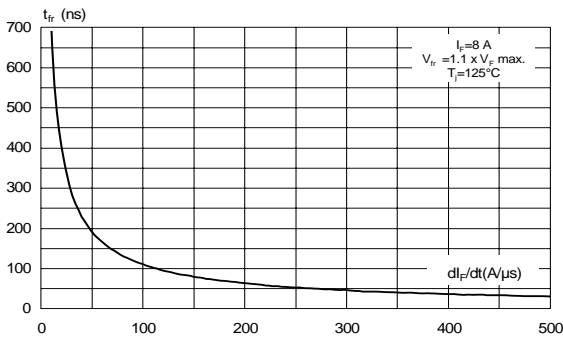


Figure 10: Junction capacitance versus reverse voltage applied (typical values, per diode)

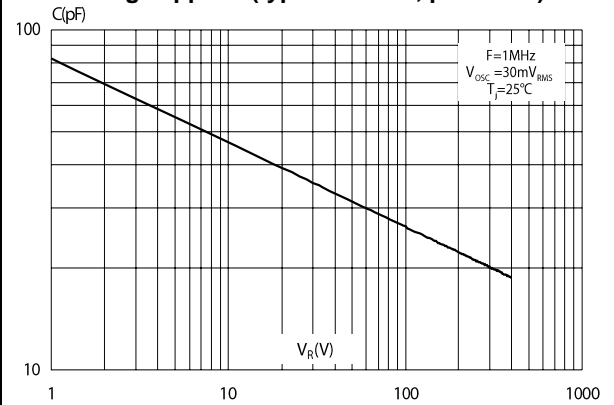
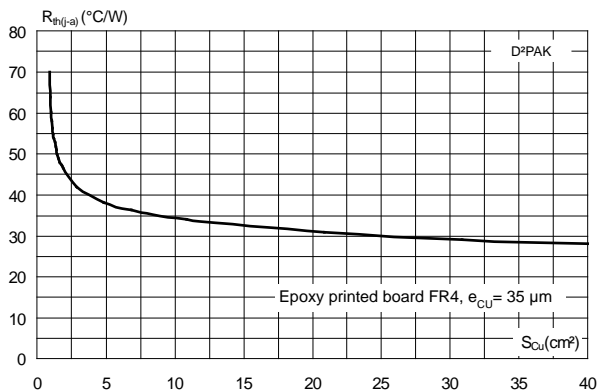


Figure 11: Thermal resistance junction to ambient versus copper surface under tab



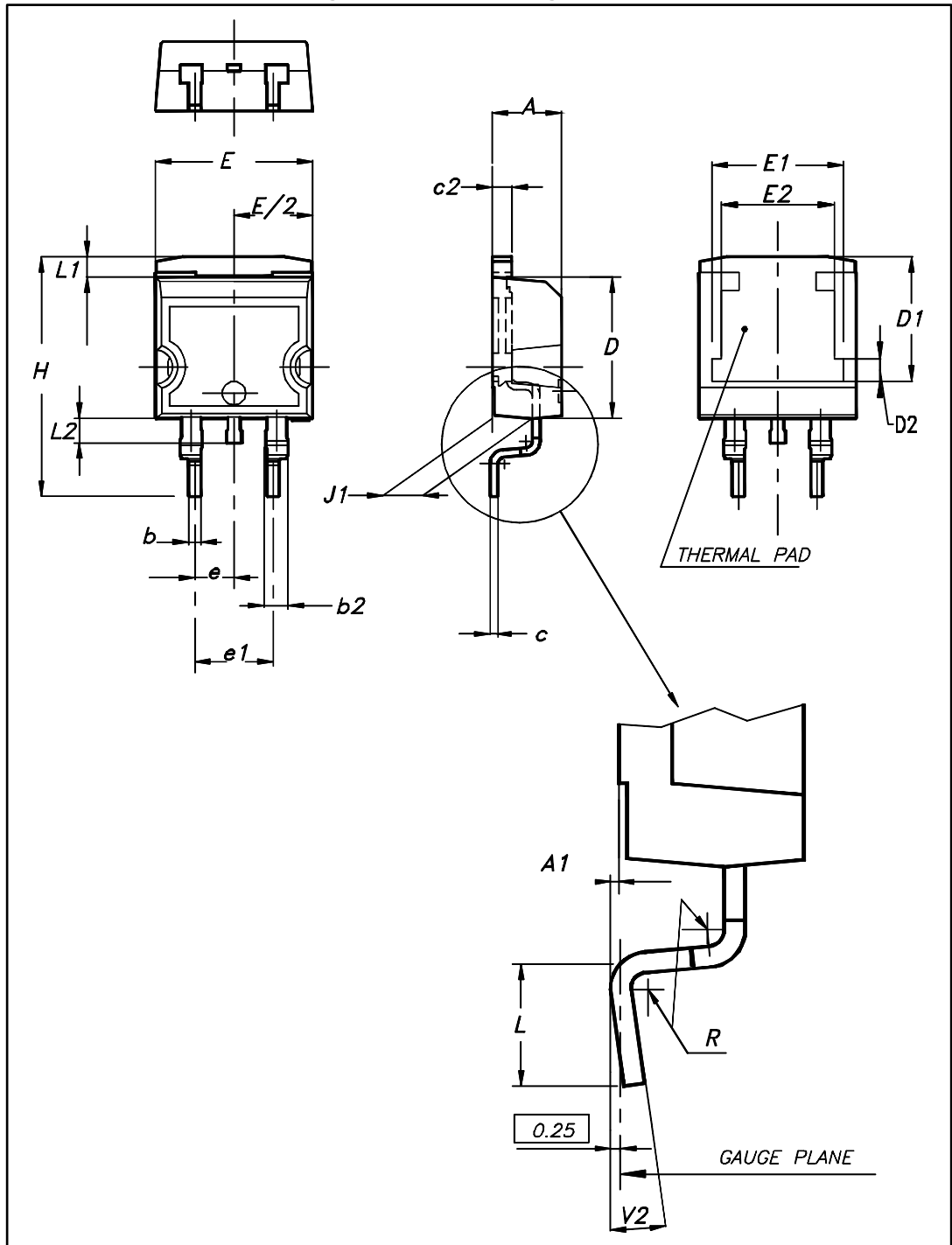
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94, V0
- Recommended torque value: 0.55 N·m (for TO-220AB)
- Maximum torque value: 0.7 N·m (for TO-220AB)

2.1 D²PAK package information

Figure 12: D²PAK package outline

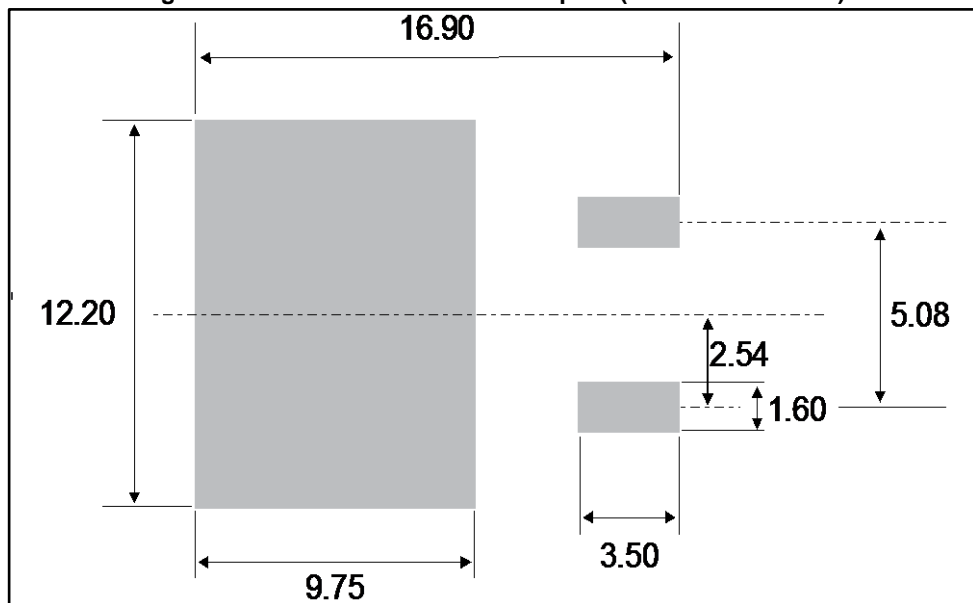


This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 6: D²PAK package mechanical data

| Ref. | Dimensions | | | |
|------|-------------|-------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 4.36 | 4.60 | 0.172 | 0.181 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 |
| b | 0.70 | 0.93 | 0.028 | 0.037 |
| b2 | 1.14 | 1.70 | 0.045 | 0.067 |
| c | 0.38 | 0.69 | 0.015 | 0.027 |
| c2 | 1.19 | 1.36 | 0.047 | 0.053 |
| D | 8.60 | 9.35 | 0.339 | 0.368 |
| D1 | 6.90 | 8.00 | 0.272 | 0.311 |
| D2 | 1.10 | 1.50 | 0.043 | 0.060 |
| E | 10.00 | 10.55 | 0.394 | 0.415 |
| E1 | 8.10 | 8.90 | 0.319 | 0.346 |
| E2 | 6.85 | 7.25 | 0.266 | 0.282 |
| e | 2.54 typ. | | 0.100 | |
| e1 | 4.88 | 5.28 | 0.190 | 0.205 |
| H | 15.00 | 15.85 | 0.591 | 0.624 |
| J1 | 2.49 | 2.90 | 0.097 | 0.112 |
| L | 1.90 | 2.79 | 0.075 | 0.110 |
| L1 | 1.27 | 1.65 | 0.049 | 0.065 |
| L2 | 1.30 | 1.78 | 0.050 | 0.070 |
| R | 0.4 typ. | | 0.015 | |
| V2 | 0° | 8° | 0° | 8° |

Figure 13: D²PAK recommended footprint (dimensions in mm)



2.2 TO-220AB package information

Figure 14: TO-220AB package outline

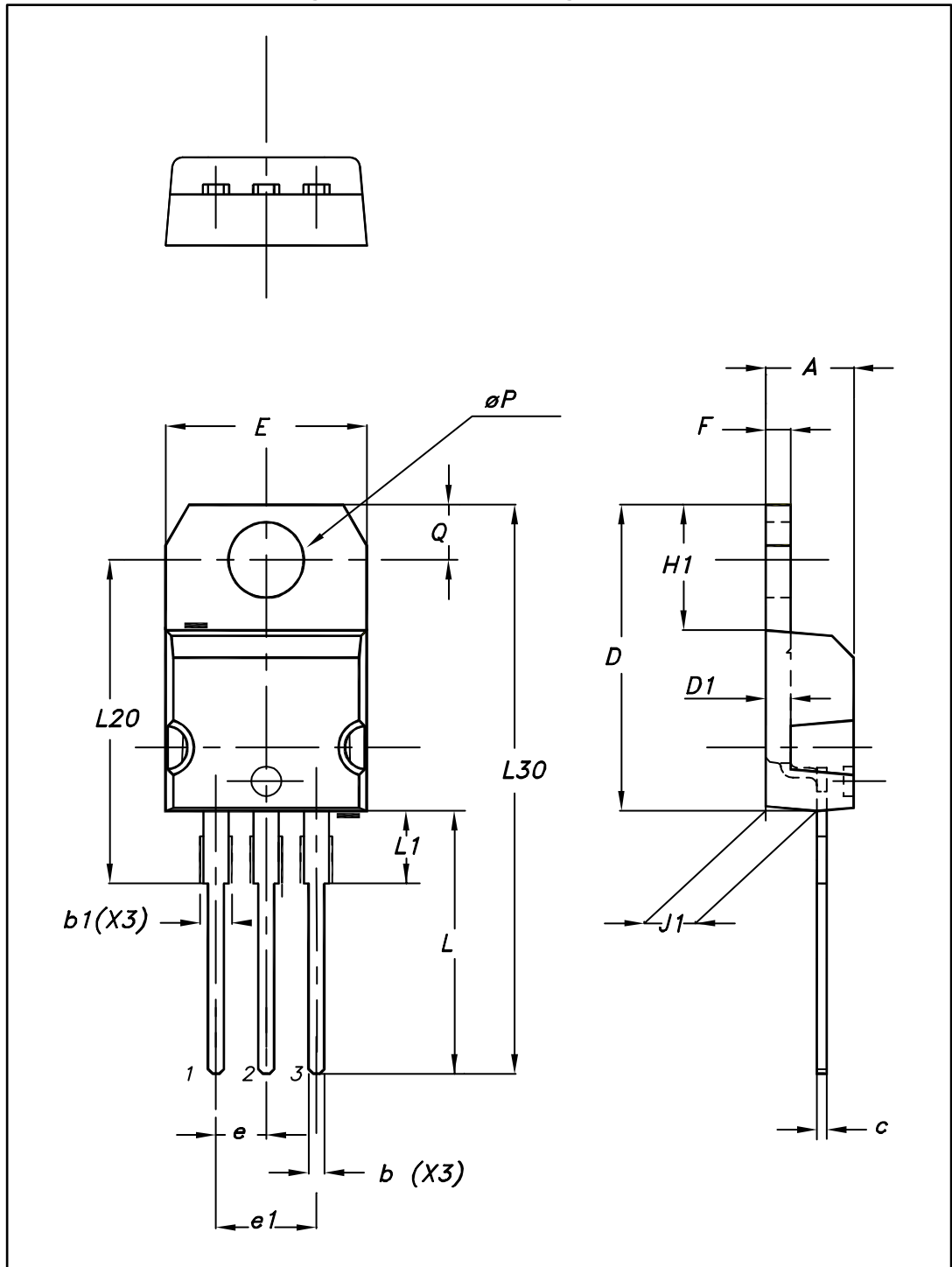


Table 7: TO-220AB package mechanical data

| Ref. | Dimensions | | | |
|------|-------------|-------|------------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 4.40 | 4.60 | 0.173 | 0.181 |
| b | 0.61 | 0.88 | 0.240 | 0.035 |
| b1 | 1.14 | 1.70 | 0.045 | 0.067 |
| c | 0.48 | 0.70 | 0.019 | 0.028 |
| D | 15.25 | 15.75 | 0.600 | 0.620 |
| D1 | 1.27 typ. | | 0.050 typ. | |
| E | 10.00 | 10.40 | 0.394 | 0.409 |
| e | 2.40 | 2.70 | 0.094 | 0.106 |
| e1 | 4.95 | 5.15 | 0.195 | 0.203 |
| F | 1.23 | 1.32 | 0.048 | 0.052 |
| H1 | 6.20 | 6.60 | 0.244 | 0.260 |
| J1 | 2.40 | 2.72 | 0.094 | 0.107 |
| L | 13.00 | 14.00 | 0.512 | 0.551 |
| L1 | 3.50 | 3.93 | 0.138 | 0.155 |
| L20 | 16.40 typ. | | 0.646 typ. | |
| L30 | 28.90 typ. | | 1.138 typ. | |
| θP | 3.75 | 3.85 | 0.148 | 0.152 |
| Q | 2.65 | 2.95 | 0.104 | 0.116 |

3 Ordering information

Table 8: Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|----------------|-------------|--------------------|--------|-----------|---------------|
| STTH16R04CT | STTH16R04CT | TO-220AB | 1.9 g | 50 | Tube |
| STTH16R04CG-TR | STTH16R04CG | D ² PAK | 1.38 g | 1000 | Tape and reel |

4 Revision history

Table 9: Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 31-Mar-2007 | 1 | First issue. |
| 02-Nov-2016 | 2 | Removed device in TO-220FPAB. Updated features, Table 1: "Device summary" and package silhouettes in cover page. Updated Section 1: "Characteristics" , and Section 3: "Ordering information" . Updated Section 2.1: "D²PAK package information" . |

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